Emerging markets, agility and advanced manufacturing: new opportunities

CENAMPS - United Kingdom Centre of excellence for nanotechnology, micro & photonic systems Speeding technology to market...

Dr Gerson Machado DIC PhD, Chief Executive Officer, gerson.machado@cenamps.com

AbineeTec 2003 - Sao Paulo 7th October 2003





Nanotechnology, Micro and Photonic Systems



- Overall nanotechnology and market issues
- Trends in international investment and technology
- Some opportunities in nanotechnology and nanomanufacture
- Polymers and electronics, minifabs opportunities
- UK MNT network and CENAMPS



A 21st century world





Dr Gerson Machado gerson.machado@cenamps.com

The source of wealth is something specifically human: *KNOWLEDGE*

Knowledge applied to tasks we already know how to do is *PRODUCTIVITY*

Knowledge applied to tasks that are new and different is *INNOVATION*

Managing for the Future: The 1990s and Beyond Peter F. Drucker, 1992



Dr Gerson Machado gerson.machado@cenamps.com

Innovation system concurrent integration



Dr Gerson Machado gerson.machado@cenamps.com

Trade balance in electronic products worldwide

Saldo Comercial de Produtos Eletrônicos - US\$ bilhões -



Dr Gerson Machado gerson.machado@cenamps.com

Semiconductors: contribution to economic growth

Figure 1. Semiconductor Contribution to Economy Leads All Manufacturers



Note: In 1987 there were 11 other manufacturing industries not shown on this figure whose contribution to the U.S. economy exceeded the contribution of the semiconductor industry. Source: Table 1.



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Semiconductors: contribution to economic growth





Source: Nathan Associates Inc.

Dr Gerson Machado gerson.machado@cenamps.com

The value of systems in the electronics industry: market sectors



Source: SEMI-SEAJ, SIA WSTS, IC INSIGHTS, Rose Associates, SEMI Consensus Forecast



Dr Gerson Machado gerson.machado@cenamps.com

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Five centres of excellence



Si

One

To generate <u>entrepreneurial wealth</u> and employment through establishing <u>sustainable technology-based activity</u> and <u>business-driven R&D</u> linked to <u>agile manufacturing</u> companies and international trade

To be a leading worldwide provider of late-stage research and <u>risk-reducing entrepreneurial services</u> for next-generation technology and product development including proof-of-principle, investment, incubation, advanced manufacturing and commercialisation activities

To <u>leverage resources and facilities</u> of partner universities and companies worldwide as appropriate to perform business-driven <u>R&D ahead of</u> <u>industrial needs by typically 1 to 5 years</u> in the fields of nanotechnology, microelectronics/microsystems, photonics and related materials, systems and commercial techniques



The four-pillar-model of technological capability

Companies

- Intra-firm effort:
- * Technological learning
- * Skills development
- * Research and development

Technology institutions

Standards, measurement + testing Quality assurance + certification Technology consultancy Management consultancy Technology information + demonstration Technology extension Research + development Intellectual property rights protection R+D financing Technology assessment



Inter-firm relationships:

- * Interactive learning
- * Technological alliances
- * Joint R+D

Education institutions

Comprehensive primary education Technology-related secondary education Vocational training Higher education * engineering * management Ongoing training Public and private providers

Framework conditions

International level National government Provincial govnmt Networking Local government

Macroeconomic policy Fiscal policy Tax policy Trade policy Competition policy

Industrial policy Economic promotion Regulations Property rights Infrastructure

International technology transfer Foreign buyers International standards Resource endowment Attitudes and values Openness to learning and change



Adapted from PACA-RALIS Jorg Meyer-Stamer 2003

Dr Gerson Machado gerson.machado@cenamps.com

Concurrent technology development and transfer



Dr Gerson Machado gerson.machado@cenamps.com

Segment	Commercialization to pursue	What to avoid
Tools	fundamental advances in nanoscale (or sub-nanoscale) techniques for visualization, measurement, and manipulation advances in process control	promises of very large near-term revenue opportunities competing on the basics of microscopy ignorance of potential entrants from semiconductor capital equipment markets
Materials	disruptive new material applications arbitrarily long nanotubes	rapid growth expectations, high investment requirements yet another carbon nanotube or nanopowder company loose grips on scalability or application value
Electronics	disruptive new electronic applications of unique nanomaterial properties	sustaining developments in microprocessors and other large, ordered arrays of transistors quantum computing
Biotech	tools to help with target identification and understanding of disease mechanisms new vehicles for drug delivery	undifferentiated new entrants into biotech field promises of rapid success in new drug process
Assemblers	none vet	getting private investment involved at this stage

Dr Gerson Machado gerson.machado@cenamps.com

Profile of current nanotech company focus





 $\label{eq:constraint} \mbox{Dr Gerson Machado gerson.machado@cenamps.com}$

WW industrial output by SIC sectors likely to be nanoinfluenced



Most sophisticated Nanotech Regions

Most promising Nanotech Applications



3i survey, Economist Intelligence Unit July 2002

Dr Gerson Machado gerson.machado@cenamps.com



Dr Gerson Macnado gerson.macnado@cenamps.com

Carbon nanotube applications





Dr Gerson Machado gerson.machado@cenamps.com

Carbon nanotubes properties

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Properties

- **Diameter:** 0.6 1.8nm (SWNT), - 100nm (MWNT & CNF)
- Electrical: Metals/Semiconductors
- **Density:** 1.33 1.40 g/cm³ (Aluminum: $2.7g/cm^3$)
- Tensile Strength: 45.109Pa (High tensile steel alloys 2.109Pa)
- Current carrying capacity: 10⁹A/cm² (Copper: 10⁶A/cm²)
- Heat Transmission: 6000 W/mK (Diamond: 3320 W/mK)
- Field Emission: 1-3 V/µm (Molybdenum tips: 50-100V/µm)
- Cost: 100-1000\$/g (Gold: 10 \$/g in Oct 2000)



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Technological impact

- Main stream microelectronic devices Many industrialists including CEO of INTEL predict that in 10-15+ years the Si industry will be complemented by 'a carbon nanotube based device architecture or molecular electronics'
- Polymer composites enhancing the properties of polymers both structurally and electrically
- Displays An emissive technology will replace the LCD screens eventually. It could be FED based on CNT structures
- Pharmaceuticals Drug delivery for efficient and therefore lower dosage, bio-molecular sensors
- Energy sources In enhancing the surface areas of Li batteries and possibly longer term hydrogen storage areas



Large-area synthesis of carbon nanofibres at room temperature











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r.f. plasma enhanced chemical vapour deposition Gases in 13.56 MHz PSU (CH_4, He, N_2) powered electrode samples **PLASMA** earthed electrode to roots/ throttle valve rotary pump 200 nm 100 °C □ 250 °C

25 35 45 55

45 55 65 75 CNF diameter (nm)

nature materials | ADVANCE ONLINE PUBLICATION | www.nature.com/naturematerials

SWNTs offer various opportunities

ELECTRICAL

Electrically Conductive Composites

Electrostatic Dissipation Shielding Conductive sealants

Energy Storage

Super Capacitors Fuel cells

Electronic Materials & Devices

Conductive inks and adhesives Electronic packaging Device and microcircuit components

MECHANICAL

High performance composites Coatings – wear-resistant and low-friction **High performance fibers** Reinforced ceramic composites

THERMAL

Thermally-conductive polymer composites Thermally-conductive paints & coatings

FIELD EMISSION Flat Panel Displays Electron device cathodes Lighting



Large and growing market

- ABS, polycarbonate, etc. with conductive "fillers" to provide: antistatic, ESD
- Plastics are replacing metals
- <u>Markets</u>
 <u>Products</u>
 - Electronics Chip trays, packaging
 - Automotive Fuel lines & filter housings, auto body panels
 - Industrial Explosion proof housings & conveying systems
- Products enabled by high conductivity or EMI/RFI shielding
 - Fuel Cells Bipolar plates, electrodes
 - Electronics Component housings, etc.
 - Aerospace Conductive sealants



Nanomanufacturing



Dr Gerson Machado gerson.machado@cenamps.com



- Engineering-directed exploration of underlying interdisciplinary nanoscale science
- Infrastructure for experimentation, theory, modeling, simulation, control
- Emphasis on nanomanufacturing education
- Collaboration with academia, industry, government and international institutions
- Emphasis on manufacturing synthesis
- Learning from nature / biomimetics
- Multi-domain technologies, multi-functional devices /systems



New engagement models with less TTM

- Identification of key opportunities
- Creation of bilateral partnerships with engineering, sales and marketing concerns worldwide
- Minority equity positions worldwide to engender trust and align goals
- Aligned protection of intellectual property
 - Critical for new generation of international start-ups
 - Important for increasing velocity of dealmaking between UK worldwide
- Recognition of what each country's companies are generally good at
 - New ideas and technology on both sides
 - Making those ideas work for worldwide customers in major trading blocks
- Focus on new applications nearing commercialisation



VentureWire Alert [mailto:alert@venturewire.com]

VentureWire Alert, Thursday, July 10, 2003

[...]

The largest round of the day went to ZettaCom, a provider of fibre-to-fibre configurable optical technologies that raised a \$19.2-million Series C coled by Investcorp and Norwest Venture Partners. Investors including China Development Industrial Bank, JPMorgan Partners, k1Ventures, US Bancorp Piper Jaffray, and Venrock Associates also participated in the round.

[...]

CHINA IS INVESTING OUTSIDE CHINA FOR ACCESS & TTM!!

OTHER COUNTRIES ALSO INVESTING WW

NEW INDUSTRIALISING COUNTRIES WILL INVEST IN DISRUPTIVETECHNOLOGIES and AGILE MANUFACTURING



Example of areas for cooperation with the North East of England / the UK

- Wireless communications
- Nanotechnology and microsystems
- Consumer electronics and agility: SoC, new materials, DET
- Photonics
- Energy generation and storage
- Hydrogen economy
- Biotech and pharmaceuticals
- Process intensification and the chemical industry
- Digital and media including creative games and GRID computing
- New venture funding and global market reach
- KEY CENAMPS FOCUS: ADVANCED FUNCTIONAL MATERIALS, BIOTECH, ELECTRONICS/PHOTONICS





Healthcare

& Thin Films



Ray Oliver ICI 2003

Dr Gerson Machado gerson.machado@cenamps.com

Chemical nanotechnologies and CENAMPS + CPI



Dr Gerson Machado gerson.machado@cenamps.com

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Indicative commercial roadmap

Pigments, Cosmetics, Sunscreens, Catalysts, Drug (A.I.) Delivery, 'Lab on a Chip', SPM/AFM, photonics, electronics... Commercial Volumes of C-nanotubes, Large area displays, Nanoscalar Powders, Next Gen. Lithography Biocompatible Composites, e-ink & e-paper Portable Energy & Power, Flexible Solar Cells.



Adv. Flat Panel Displays, incl OLED's & FED's, Adv. Batteries, Solar Cells, Biosensors, Low Cost Synthesis of C-SWNT/MWNT Micro Fuel Cells, Photovoltaic Cells Macro Fuel Cells, Nanoelectronics, Plastic Chips, Flexible Displays Bottom-up Molecular Fabrication, First Biomimetic Composites.



Modified from Ray Oliver ICI - 2002

Dr Gerson Machado gerson.machado@cenamps.com

Cenamps/Durham advanced agile manufacturing programme

•Practical understanding of **manufacturability** as related to emerging minifab market opportunities with polymers, semiconductors, biotech and photonics

•Pilot and introduce smaller scale, highly scalable, transformable and modular production technology covering the whole spectrum of semiconductor fabrication

•Integrate laboratory based work at universities with higher scale, pilot environments in industry and systems optimisation digital enterprise work to facilitate Agile Design and Manufacture

•Planning and synchronisation methods for the new generation agile semiconductor / hybrid facilities and their respective production networks

•Risk mitigation for industrial implementation by the introduction of physics based modelling, simulation and real-time control to predict manufacturability, adaptability and reliability.

•Develop and deploy advanced **Digital Enterprise Technology** based workflow methods and computational tools for managing collaborative and distributed innovation in new products, manufacturing systems and business processes.

•Industrial feasibility studies, technology management, business and network analysis and evaluation for disruptive technologies.

•Effective life-cycle management of the design, production technology and production network operations to ensure long-term competitiveness and ability to rapidly respond to dynamic market changes.



Brazil-UK research networks bring mutual benefits

• A report published today (12 June 2003) found that the UK and Brazilian academics benefited from the opportunities of working more closely and had planned further activities in the future.

Groups of UK and Brazilian scientists, funded by the Higher Education Funding Council for England (HEFCE) and Brazilian federal and state agencies, have been collaborating on industry-related research projects for the past three years. The networks are in the areas of industrial catalysis, corrosion protection (both primarily geared towards the oil and gas industries) and phytopharmaceuticals.

The principal aim of the project was to find out if research programmes, led by consortia of UK and Brazilian universities and research centres, could be enhanced through international collaboration, and to find out if university expertise could be exploited to the mutual advantage of universities and industry in the two partner countries.

The report, 'UK-Brazil Collaborative Research Networks: evaluation of pilot project', available from HEFCE's web-site www.hefce.ac.uk and the Brazilian Embassy web-site www.brazil.org.uk, considers how each network developed and offers advice to anyone wishing to set up similar networks. Around £225,000 was given to the UK networks, with each having access to up to £33,000 per year. The UK networks were expected to raise funding for research projects from industry or Research Council grants and other sources.

www.hefce.ac.uk/Pubs/RDreports/summary/summ32.htm [



Dr Gerson Machado gerson.machado@cenamps.com

NE cluster linkages



Chemicals cluster R&D spend in the NE

 Greater than £ 90 million from 7 leading P&S companies alone



 The companies are classified as pharmaceuticals/biosciences, catalysts, surfactants, consumer/industrial products



Dr Gerson Machado gerson.machado@cenamps.com
Attractiveness of the segments will be influenced by growth prospects and profitability



MNT market: breakdown by technology

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Polymer microsystems applications overview



Combining silicon, polymers and hybrids

From silicon to polymers



Dr Gerson Machado gerson.machado@cenamps.com

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Polymer microsystems applications market - 2005





Time



 $\label{eq:constraint} \mbox{Dr Gerson Machado gerson.machado@cenamps.com}$



Current Healthcare





Initial Visit





Biopsy/Removal



Pathology



Chemotherapy/Radiation

- Many Visits (Doctors don't talk)
- Long Period of Time
- Detection is too late
- Poor quality of life (anemic, hair/weight loss, deplete bone marrow)
- High Cost
- Significant Death Rate

Future Healthcare with Nanotechnology





Nanoparticles

- Two Visits
- Short Period of Time
- Early detection
- Better quality of life
- Low Cost
- Reduced Death Rate



Dr Gerson Machado gerson.machado@cenamps.com

Facilities to equipment costs





M+W Zander 2003

Dr Gerson Machado gerson.machado@cenamps.com

Semiconductors: megafabs and minifabs

- A fab today is expected to mass-produce millions of chips monthly over several years in order to justify construction price tags over \$2 billion, but system-on-chip SoC shipments generally peak at 200,000 units or less
- SoC orders are three or four digits smaller than orders for DRAMs
- SoC chips require quick turnaround and are composed of a wide mix of components, including CPUs, DRAMs, SRAMs, flash, logic and analogue
- Production can change almost daily: difficult to precisely control
- Joint private, academic and government project to create minifabs that are just 10% the size and cost: minifab capacity of 100 lots/month (2500 wsm)



Paradigm business shifts in the semiconductor industry

- Trend in broadband-networked digital consumer electronics
- Shorter cycle-time minifab operations, single-wafer cleaning
- Stringent surface contamination control requirements
- Environmentally friendly technologies
- Changes required of gate-insulator materials and forming methods

DRAM Era	System-on-a-Chip Era				
Personal computer	Networked digital consumer electronics				
DRAM	System LSI (or SOC)				
Capital spending	Knowledge creation on silicon				
Commodity sales	Solution offering				
Long cycle times (longer than 3 years)	Short cycle times (typically a few months				

Many companies are investigating adoption of the new paradigm including Sony, Toshiba, Toyota, Sharp, Sanyo, Epson, Rohm, Tokyo Electron, Ebara, DNS, Ulvac, Shimizu, Obayashi, Taisei together with several leading universities and the Ministry of Economy, Trade and Industry of Japan (METI) -HALCA project (Highly Agile Line Concept Advancement) Dr Gerson Machado gerson.machado@cenamps.com

Paradigm technology shifts in the semiconductor industry

Technology Area	DRAM Era	System-on-a-Chip Era			
Product mix	Low	High			
Product volume	High	Low or variable			
Fab size	Megafab	Minifab (or multiple miniline fabs ¹)			
Market driver	High throughput	Short cycle times			
Process model	Batch processing	Single-wafer processing			
Inspection model	Long-loop feedback	Short-loop feedforward			
Yield management	Steady enhancement	Prompt, accurate estimation			



Dr Gerson Machado gerson.machado@cenamps.com

Production volume over time at a megafab (a) and a minifab (b)





Dr Gerson Machado gerson.machado@cenamps.com

Production volume over time at a megafab (a) and a minifab (b)





Dr Gerson Machado gerson.machado@cenamps.com

The 12 UK Regions 12 UK Development Agencies (DAs)

9 English Regional Development Agencies:

- A. South West of England
- B. South East of England
- C. London
- D. Advantage West Midlands
- E. East Midlands
- F. East of England
- G. North West
- H. One North East
- I. Yorkshire Forward

3 Devolved Administrations:

- J. Northern Ireland
- K. Scotland
- L. Wales





Technology insertion: combining a hub and spoke model with national strengths





Dr Gerson Machado gerson.machado@cenamps.com

CENAMPS - opportunity for collaboration

- A combination of physical and distributed facilities
- State-of-the-art facilities for research and small volume manufacturing at Newcastle and Durham universities
- Most modern facilities in the UK for semiconductor and compound semiconductor manufacturing both world class
 - Atmel site mini-environment
 - Filtronic largest compound semiconductors plant in Europe
 - Small & large companies already active in micro/nano/photonics
- Large chemical nanotechnology cluster already in billion+ nano exports
- Tradition in manufacturing, best return on capital of any region in UK
- International and national synergies



Automotive & Aerospace, Information & Comms Technology, Advanced Manufacturing & Materials, Security

Filtronic Compound Semiconductors Newton Aycliffe, UK

Excellent transport links – less than 1 hour by air to major European cities and major OEMs

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Dr Gerson Machado gerson.machado@cenamps.com

Automotive & Aerospace, Information & Comms Technology, Advanced Manufacturing & Materials, Security





Dr Gerson Machado gerson.machado@cenamps.com

Objective of capital projects fund is to...

- Accelerate the commercialisation of MNT for the wider benefit of the UK economy
- Provide open access (on fair and equitable terms) to Microsystems and Nano Technology platforms and associated knowledge
- Development of critical mass of capability whilst avoiding duplication of provision



" Industry/market facing UK based facilities which provide cost-effective open access for organisations and individuals to capabilities, processes and associated knowledge leading to marketable products, and services."



Dr Gerson Machado gerson.machado@cenamps.com

Creating wealth from the technology/research base of UK by:

Improving the competitiveness of existing companies through regeneration of the technology base of those companies, leading to products with more competitive cost and/or performance with other global players

Starting new companies to deliver globally competitive MNT products and services.



Improving the Competitiveness of UK industry by:

- Enabling the development of new products and processes that can compete in global markets
- Improving productivity through greater automation, more efficient processes and better use of resources in all parts of the technology supply chain
- Reducing time to market for MNT based products and services by speeding up the technology development and transfer processes and:
- Increasing the number of suitably skilled people available to organizations throughout the supply chain
- Fostering effective supply chain partnerships that strengthen the technology supply chain for UK industry



Starting New Companies by

- Funding Applied Research that will lead to products and services that can be spun out into viable commercial enterprises.
- Developing Entrepreneurship Skills to provide leadership for start-ups.
- Providing Incubator Facilities to help start-ups through their early phases of assistance.
- Improved Access to Funding/Grants.
- Developing and Protecting IP that is the core of the products or services that are spun out.



Technology Transfer Institutes Research and Development Centres Military Research Centres Commercial Companies Academic Research Institutes



Dr Gerson Machado gerson.machado@cenamps.com

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Organisation	Туре	Age	Financials	Commercial Revenue	Research Revenue	Staff	Researchers / Engineers	Students / Operators	Areas	Spinouts
ACREO	Tech Transfer	~5	Eqpmnt E18M Budget E14M	Total revenue 2002 €25.6		202 in 2002			10	9 in 4 years
APM	Device/founrdry	~2	Capital \$50M			212	E ~ 70	O ~ 30	6 (Si)	
Bosch	MPW service	5 yrs	N/A	NA	NA, EU 50% fund	5	5	Shared	3 (Si)	18 runs
BSAC	r+D	6+yrs		Industry Subscription		130	120	Shared	11	3++
Cambs IRC	R (PhD)	~1	Equip E3.3M Facils E7M		E3M	60		12	2	
CRC Aus	Tech Transfer	~2		\$Au64M		100	60	30	11	1+2coming
Cronos	Device/founrdry	4	val\$38M			80			3 (Si)	
CSEM	Tech Transfer	>5	Capital E27M Budget E40M	Total revenue €4M		350			7	11/5yrs
DALSA	Semis, MEMS	?	Rev \$112M						1	
DIMES	R+D	>5	Capital E6M		E21M	~260	160	80	5	
Fraunhofer IZM	Tech Transfer	10		E11M	E11M	355	170	170	8	
IMEC	D/Tech trans	10+	Invest E70M	E53	E53	1200	912	200?	11	19 tot
INEX	Tech Transfer	>3	Invest E14M			30			7	2 tot
ITRI	Tech Transfer	>15	Facils E30 Equip E27	\$219M	\$256M	4590	3535	370	4 (Si)	100 (incl TSMC?)
Kelvin Nano	Tech Transfer	~5		E6.4M		110	55	25	2	1
Kist	R+D	>5yrs	IIMC £13.2M			330 (14 IIMC)		19		
KTH	R+d	>10		SKr3	SKr 52	29	29	70	4	
LETI	D/Tech trans	>10	Invest E200M E20M/yr	E40M	E80M	774	570	200	10	~30 tot
MC2	R	~5	Invest E80M tot Facils E17M Equip E15M		E18M	220			5	
MCNC	Tech Transfer	>5							7	Cronos+
Mesa +	R+D	>5	Capital E160M	E5M	E15M	380			5	9/2yrs
MIC	Tech Transfer	>5	Equip E20M Facils E4M	E2.5M	E3.7M	110			7	10/5yrs
Micralyne	D/Manuf	>5		E6M		100			10	1
MIT - MTL	R+d									4+
NMRC	r+D	>10		E11.7M	E3M	97			11	2(2001)
PHS MEMS	D/Manuf	5	Invest E40M			75			5(coms	\$)
RAL CLRC	r+D	>5	Invest E35M	E7.5M	E7.5M		50	30		
Sandia	R+D	>10	Invest \$114M		\$50M	274			5	1 (MEMX)
Scottish MC	R+d	>10	Invest E13M			30			4	4
Nanofab Facil	R		Invest \$64M	\$24M	\$16M	200 Open lab	facility for mem	nbers)	8(Si)	~2
Walsin	Manuf	>10	Equip \$50M						~3	
Warwick Uni	R				E5.5M	16			2(Si)	



Dr Gerson Machado gerson.machado@cenamps.com



Performance measurement: papers



Dr Gerson Machado gerson.machado@cenamps.com

Performance measurement: patents

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Dr Gerson Machado gerson.machado@cenamps.com

Performance measure: PhDs



Dr Gerson Machado gerson.machado@cenamps.com

Performance measure: spin-out companies





Total revenue comparison



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Dr Gerson Machado gerson.machado@cenamps.com

Cenamps services and functions to support volume manufacturing and technology access



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Dr Gerson Machado gerson.machado@cenamps.com

The sustainability cycle



Preferred criteria for investment focus

- Cenamps and NSTAR will help to <u>bridge the gap from laboratory to later</u> <u>stage funding</u> including grants, seed, early stage and first round funding; typically 1-3m GBP at first round, less for seed. Key areas:
 - Novel and advanced materials for industrial and medical use, such as metals, alloys, glass, ceramics, industrial chemicals (organic and inorganic), plastics, composite materials and novel polymers.
 - Innovative industrial processes for production of advanced materials or aimed at substantially reducing the costs of production (process intensification)
 - Biotech
 - Electronics and photonics including semiconductors
 - Companies that can produce not only raw materials or devices but also applications and particularly systems
 - Market technology horizon up to about five years; e.g. nano-based cosmetics, lab-on-a-chip technology, flat panel displays, medical devices, optical technology that impacts broadband or medical apps.
 - Support for partnering and for helping companies locate in the UK.



Building a model... Early stages of exploitation of science & tech...





Dr Gerson Machado gerson.machado@cenamps.com
Micro- Nano- Photonic (MNP) Cluster



Dr Gerson Machado gerson.machado@cenamps.com

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The CENAMPS hub & route to market



Product areas: micro- & flexible displays; lab-on-chip; microreactors; fuel cells; drug delivery; home medical systems; consumer smart materials; high performance materials & coatings; bio- & chemical sensors; RF & THz systems; MEMS & MOEMS; imaging chips



Plenty of areas to work on...

- Material precursors: nanoparticles and nanostructures
- Processes for fabrication and integration:
 - Bottom-up synthesis vs top-down miniaturization convergence
 - \Rightarrow Novel and hybrid processes, multi-domain processing
 - \Rightarrow 3-D processing techniques: ultrasonic, imaging
 - \Rightarrow Massively parallel processes for productivity and quality
- Theory, modeling, simulation and control
- Instrumentation: sensors and actuators
- Design and Integration of functional nanodevices (in vivo, in vitro, biomimetic)
- System architectures across dimensional scales



Cenamps international services: development, training, investment & commercialisation

- Technology development and insertion
 - Find the appropriate technology partners, develop the technology, find the right business
- Early stage investment and venturing
 - Finding investors, equity gap funding, due diligence
- Market assessment and market analysis
 - Where will the market be, how big will it be market structure and trends Partnering
 - Market & production resources, tactical & strategic partnerships
- Strategic planning and business creation activity
 - Business plans, emerging trends, technology audits & foresight, product development, marketing & technology proof of principle



Current Cenamps projects - lets work together www.cenamps.com

- Nano-Electronics Systems Centre
- Pilot Line for Next Generation Display Technology
- Active Polymer Materials Centre
- Agile Manufacturing Mini-Fabs
- Transmission Electron Microscope (TEM)
- Si Manufacturing Node
- UIC Nanotechnology Institute at Newcastle University bionano
- Laboratory for Processing Hybrid Nanostructures
- Nano-Chemical Analysis Laboratory
- Nano scalar/structured materials, products and processes programme
- Nano materials and characterisation programme
- Open Access R&D and Manufacturing
- Advanced displays (Community Hub)
- Cenamps epitaxy services
- EPSRC electronics manufacturing research

